

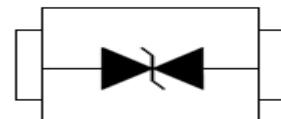


FEATURES

- ✧ Small body outline dimensions:
0.063" × 0.032" (1.6×0.8 mm)
- ✧ Protects one bi-directional I/O line
- ✧ Low clamping voltage
- ✧ Working voltage: 5V
- ✧ Low leakage current
- ✧ RoHS compliant
- ✧ AEC-Q101 qualified



SOD-523



Pin Configuration

MAIN APPLICATIONS

- ✧ Cell phone handsets and accessories
- ✧ Microprocessor based equipment
- ✧ Personal digital assistants (PDA's)
- ✧ Notebooks, desktops, and servers
- ✧ Portable instrumentation
- ✧ Peripherals
- ✧ Digital cameras

PROTECTION SOLUTION TO MEET

- ✧ IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact)
- ✧ IEC61000-4-4 (EFT) 40A (5/50ns)
- ✧ IEC61000-4-5 (Lightning) 5A (8/20μs)

MECHANICAL CHARACTERISTICS

- ✧ SOD-523 package
- ✧ Molding compound flammability rating: UL 94V-0
- ✧ Weight 0.5 milligrams (approximate)
- ✧ Quantity per reel: 5,000pcs
- ✧ Lead finish: lead free
- ✧ Marking code: 5XB

ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation on 8/20μs waveform	P_{PP}	100	W
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/- 30 +/- 30	kV
Lead soldering temperature	T_L	260 (10 sec.)	°C
Operating junction temperature range	T_J	-55 to +125	°C
Storage temperature range	T_{STG}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse working voltage	V_{RWM}				5.0	V
Reverse breakdown voltage	V_{BR}	$I_T=1\text{mA}$	5.5			V
Reverse holding voltage	V_H	$I_H=50\text{mA}$	5.5			V
Reverse leakage current	I_R	$V_{RWM}=5\text{V}$			0.1	μA
Clamping voltage	V_C	$I_{PP}=1\text{A}, t_P=8/20\mu\text{s}$		9	10	V
		$I_{PP}=5\text{A}, t_P=8/20\mu\text{s}$		13	15.5	V
Junction capacitance	C_J	$V_{RWM}=0\text{V}, f=1\text{MHz}$		7.5	15	pF

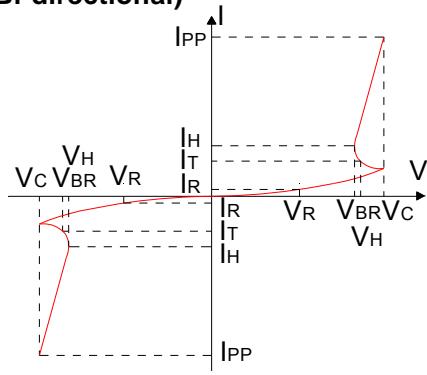
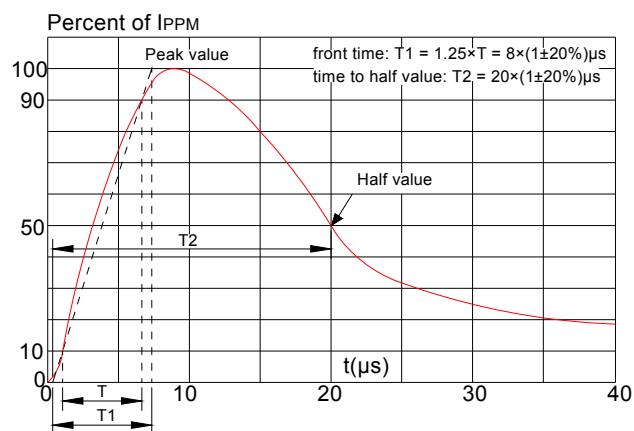
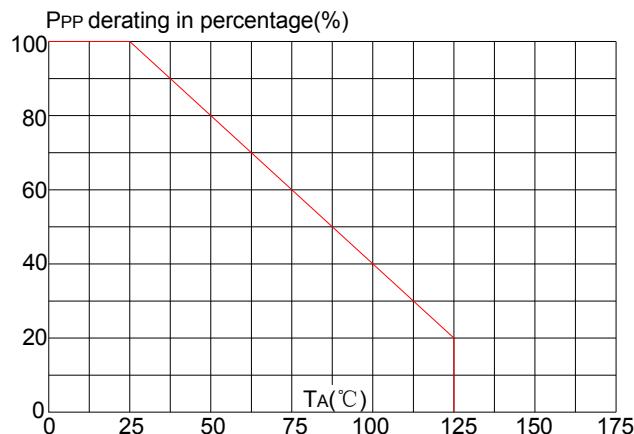
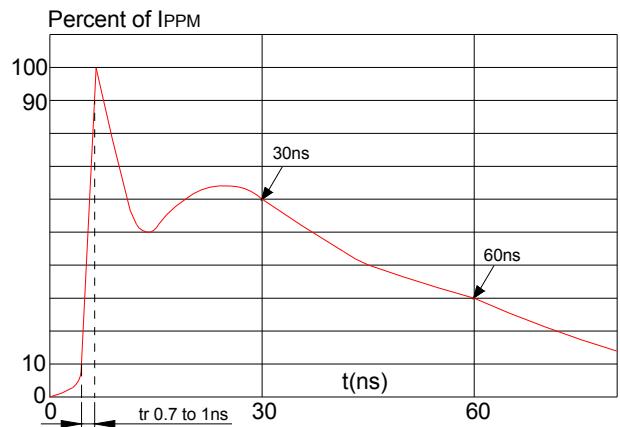
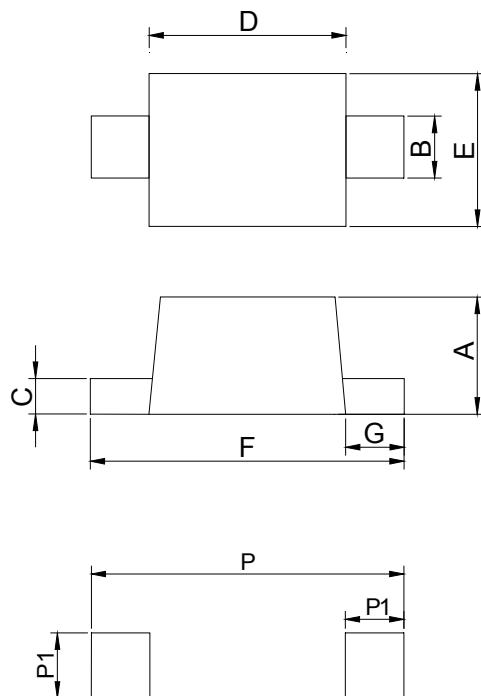
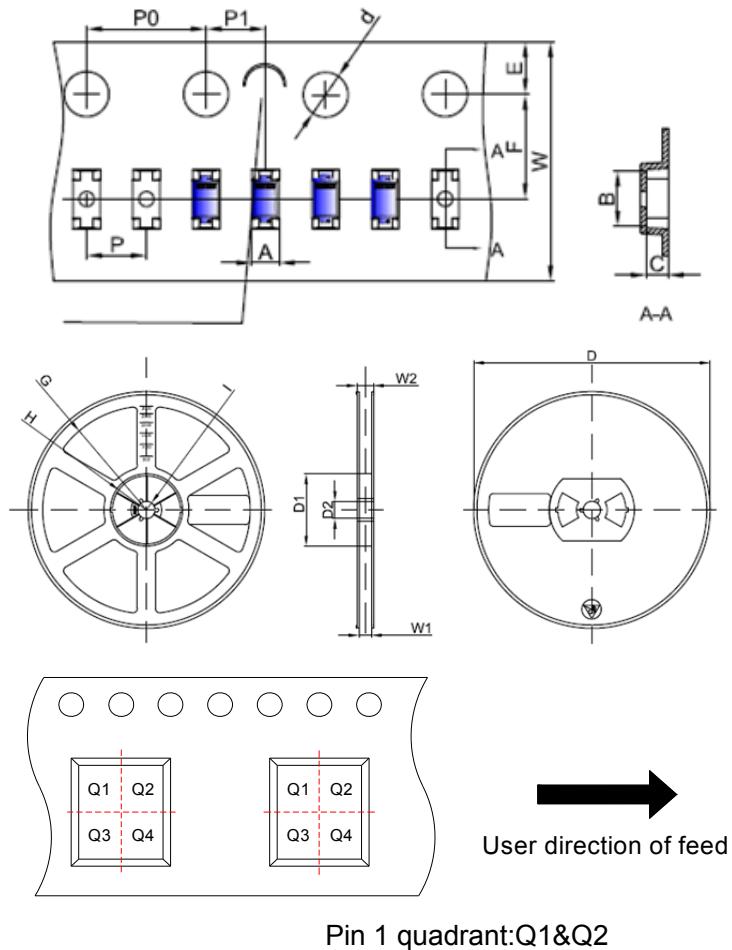
RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)**FIG.1: V- I curve characteristics
(Bi-directional)****FIG.2: Pulse waveform (8/20μs)**

FIG.3: Pulse derating curve**FIG.4: ESD clamping (30kV contact)****PACKAGE MECHANICAL DATA**

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.50	0.70	0.020	0.028
B	0.25	0.35	0.010	0.014
C	0.07	0.20	0.0028	0.0079
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
F	1.50	1.70	0.059	0.067
G	0.15	0.25	0.006	0.010
P1	0.40		0.016	
P	1.80		0.072	

Land Pattern

TAPE AND REEL SPECIFICATION-SOD-523



Symbol	Millimeters	Inches
	Typ.	Typ.
A	0.90	0.035
B	1.94	0.076
C	0.73	0.029
d	Φ1.50	Φ0.059
E	1.75	0.069
F	3.50	0.138
P0	4.00	0.157
P	2.00	0.079
P1	2.00	0.079
W	8.00	0.315
D	Φ178	Φ7.008
D1	54.40	2.142
D2	13.00	0.512
G	R78.00	R3.071
H	R25.60	R1.008
I	R6.50	R0.256
W1	9.50	0.374
W2	12.30	0.484

Packaging Description:

SOD-523 parts are shipped in tape. The carrier tape is made from a dissipative(carbon filled) polycarbonate resin. The cover tape is a multilayer film(heat activated adhesive in nature)primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and made of polystyrene plastic(anti-static coated).

ORDERING INFORMATION

PART No.	PACKAGE TYPE	QUANTITY(PCS) REEL	DESCIPTION
JEB05D5H	SOD-523	5,000	7 inch reel pack

MARKING CODE

Part Number	Marking Code
JEB05D5H	

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